

## **WEST Search History**

DATE: Friday, August 22, 2003

Set Name side by side		Hit Count S	et Name result set
DB=USPT,PGPB,JPAB,EPAB,DWPI,TDBD; THES=ASSIGNEE; PLUR=YES; OP=AND			
L7	L6 and (pad or applicator or absorbent or adsorbent)	16	L7
L6	L5 and (voltage or potential)	109	L6
L5	plating near25 deplating	161	L5
L4	L3 and (pad or applicator or absorbent or adsorbent)	55	L4
L3	L2 and L1	278	L3
L2	(voltage or potential) near25 ((deplat\$10 or remov\$10 or dissolv\$10) near3 (metal or material or layer or film or coating or copper))	6946	L2
L1	((first or initial or primary or starting or beginning) near3 (voltage or potential)) near25 (deposit\$10 or plat\$10 or electroplat\$10 or electrodeposit\$10 or electroly\$10 or electrochem\$10)	6568	L1

END OF SEARCH HISTORY



Total Assignments: 1

Applicati n #: 09961134 Filing Dt: 09/21/2001

Patent #: NONE

**Issue Dt:** 

PCT #: NONE

**Publication #: 20030057097** 

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Inventors: Stan Tsai, Shijian Li

Title: Method and apparatus for forming metal layers

Assignment: 1

Reel/Frame: <u>012202/0307</u> Received:

Recorded: 09/21/2001

Mailed: 12/03/2001 Pages:

Conveyance: ASSIGNMENT OF ASSIGNORS INTEREST (SEE DOCUMENT FOR DETAILS).

Assignors: TSAI, STAN

**Exec Dt:** 09/21/2001

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Search Results as of: 8/22/2003 10:55:52 A.M.

If you have any comments or questions concerning the data displayed, contact OPR / Assignments at 703-308-9723 Web interface last modified: Oct. 5, 2002